OFFICIAL PRODUCT CATALOG · 2026 EDITION

SHENZHEN LINGC INDUSTRIAL CO., LTD.

MOBILE STORAGE & COMPUTER PERIPHERALS

OEM / ODM Custom Manufacturing Solutions for Global Brands & Wholesalers

5,000 ㎡
Shenzhen Factory

ISO Certified
9001 · 14001 · 45001

22 Patents
Authorized IP

54 Models
6 Product Lines

Shenzhen LingC Industrial Co., Ltd. (深圳市零创实业有限责任公司)
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SOURCE FACTORY ADVANTAGE

Engineered for Reliability, Scaled for Global Delivery

Shenzhen LingC Industrial Co., Ltd. is a dedicated high-tech manufacturer specializing in mobile storage and computer peripherals. With our 5,000 square meter ISO-certified manufacturing facility in Bao'an, Shenzhen, we integrate SMT placement, high-precision assembly, automated laser marking, and rigorous high-low temperature burn-in testing under one roof.

Manufacturing Infrastructure

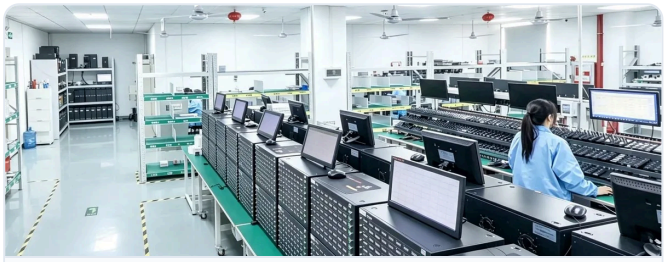
- **5,000 m²** modern dust-free workshops in Bao'an, Shenzhen.
- High-speed SMT lines, ultrasonic welding, laser engraving, and automated packaging lines.
- Daily production capacity exceeding 50,000 units with agile small-batch OEM response.

Quality Verification & Traceability

- **100% Original Grade-A Flash Wafers**: Strict wafer screening and bad-block mapping.
- **Hardware Burn-In (BIT)**: 100% full-capacity read/write cycling and temperature shock testing.
- Certified by **ISO 9001:2015, ISO 14001:2015, ISO 45001:2018, CE, FCC, RoHS**.



Automated SMT & Precision Assembly Workshop



Full-Capacity Burn-In & Reliability Testing Lab

3-YEAR WARRANTY	2-YEAR WARRANTY	1-YEAR WARRANTY	AGILE LEAD TIME
USB Hubs & Card Readers	Memory Cards & SSDs	USB Flash Drives	Samples 3-5d · Bulk 7-15d

PRODUCT LINE CATALOG

USB Flash Drives

Classic, Metal, Swivel, OTG Dual-Port & Ultra-Compact Drives

High-durability OEM/ODM USB drives for enterprise promotion, industrial systems, and everyday business backup. Full custom options including laser engraving, silk-screen, custom packaging and capacity from 4GB to 256GB.



FD1021 USB2.0

Metal Classic USB Flash Drive

Capacity	4GB~64GB
Interface	USB 2.0
Material	Zinc alloy
MOQ	MOQ: 100 pcs



FD1029 USB2.0

Metal Mini USB Flash Drive

Capacity	4GB~64GB
Interface	USB 2.0
Material	Zinc alloy
MOQ	MOQ: 100 pcs



FD1003 USB2.0

Rotating USB Flash Drive

Capacity	4GB~64GB
Interface	USB 2.0
Material	ABS + stainless steel
MOQ	MOQ: 100 pcs



FD2005 USB3.2 Gen1

USB 3.2 Metal Swivel Flash Drive

Capacity	32GB~512GB
Interface	USB 3.0
Material	Zinc alloy
MOQ	MOQ: 100 pcs



FD2001 USB3.2 Gen1

Dual-Head USB 3.2 Flash Drive

Capacity	32GB~512GB
Interface	USB 3.0 + Type-C
Material	Zinc alloy
MOQ	MOQ: 100 pcs



FD2128 USB3.2 Gen1

Mini Dual-Head USB 3.2 Flash Drive

Capacity	32GB~256GB
Interface	USB 3.0 + Type-C
Material	Zinc alloy
MOQ	MOQ: 100 pcs

Custom logo printing (Laser / Silk-screen), bespoke packaging, and custom capacity configuration available. Contact sales for live tier pricing.

PRODUCT LINE CATALOG

Memory Cards

Class 10, UHS-I U1 / U3, V30 & A1/A2 MicroSD / SD Cards

Engineered for dashcams, security surveillance, drones, mobile tablets, and photography. Waterproof, temperature-proof (-25°C to 85°C), shockproof and X-ray proof with continuous 4K video recording support.

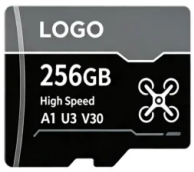


TFP3310

SD3.0 SDR104

Premium TF Card

Capacity	32GB~256GB
Interface	TF
Material	Epoxy resin
MOQ	MOQ: 100 pcs



TFH3320

SD3.0 DDR200

High-Speed TF Card

Capacity	64GB~512GB
Interface	TF
Material	Epoxy resin
MOQ	MOQ: 100 pcs



TFS3310

SD3.0 SDR104

Standard TF Card

Capacity	32GB~256GB
Interface	TF
Material	Epoxy resin
MOQ	MOQ: 100 pcs



SDP3310

SD3.0 SDR104

Premium SD Card

Capacity	32GB~256GB
Interface	SD
Material	ABS plastic
MOQ	MOQ: 100 pcs

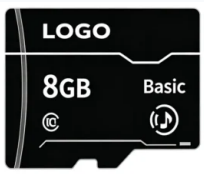


SDH3320

SD3.0 DDR200

High-Speed SD Card

Capacity	64GB~512GB
Interface	SD
Material	ABS plastic
MOQ	MOQ: 100 pcs



TFB0100

SD2.0 SDR50

TF Card Basic

Capacity	4GB~32GB
Interface	TF
Material	Epoxy resin
MOQ	MOQ: 100 pcs

Custom logo printing (Laser / Silk-screen), bespoke packaging, and custom capacity configuration available. Contact sales for live tier pricing.

PRODUCT LINE CATALOG

Internal Solid State Drives

M.2 NVMe PCIe 4.0 / 3.0 & 2.5" SATA III SSDs

High-performance internal storage designed for laptops, desktops, and industrial PCs. Equipped with advanced LDPC error correction, graphene cooling pads, and original 3D NAND flash for maximum reliability.



NV001 PCIe3.0×4

M.2 NVMe PCIe 3.0 SSD

Capacity	256GB~2TB
Interface	M.2
Material	PCB
MOQ	MOQ: 100 pcs



NV002 PCIe4.0×4

M.2 NVMe PCIe 4.0 SSD

Capacity	256GB~2TB
Interface	M.2
Material	PCB
MOQ	MOQ: 100 pcs



ST001 SATA3.0

2.5" SATA SSD

Capacity	128GB~2TB
Interface	SATA3.0
Material	ABS plastic
MOQ	MOQ: 100 pcs

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PRODUCT LINE CATALOG

Portable Solid State Drives

High-Speed Aluminum Pocket PSSDs with Type-C

Compact, shock-resistant high-speed portable SSDs with read speeds up to 1050 MB/s. Direct plug-and-play connection to PC, Mac, iPad, and Android smartphones for rapid 4K video editing and on-the-go data transfer.



PS2006

USB3.2 Gen1

Hardware-Encrypted PSSD

Capacity	256GB~2TB
Interface	Type-C
Material	Zinc alloy
MOQ	MOQ: 100 pcs



PS2007

USB3.2 Gen1

High-Speed Portable SSD

Capacity	256GB~2TB
Interface	Type-C
Material	Aluminum alloy
MOQ	MOQ: 100 pcs



PS2008

USB3.2 Gen1

Colorful Magnetic PSSD

Capacity	256GB~2TB
Interface	Type-C
Material	ABS plastic
MOQ	MOQ: 100 pcs

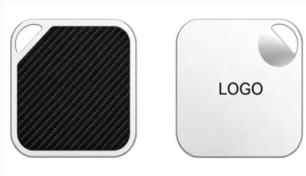


PS2012

USB3.2 Gen1

Magnetic Portable SSD

Capacity	256GB~2TB
Interface	Type-C
Material	Aluminum alloy
MOQ	MOQ: 100 pcs



PS5005

USB3.2 Gen2×2

Extreme Magnetic PSSD

Capacity	512GB~2TB
Interface	Type-C
Material	Aluminum alloy
MOQ	MOQ: 100 pcs



PS5590

USB3.2 Gen2×2

Extreme Slim PSSD

Capacity	512GB~2TB
Interface	Type-C
Material	Aluminum alloy
MOQ	MOQ: 100 pcs

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PRODUCT LINE CATALOG

USB Hubs & Multi-port Docks

4-Port to 7-Port High-Speed Hubs with Individual Power Switches

Industrial and commercial USB 3.0 / Type-C hubs and desktop docking stations. Features 5Gbps transfer rates, independent power switches, built-in surge protection, and premium aluminum alloy enclosures.



HB2011 USB3.2 Gen1

USB 3.0 4-Port Hub

Capacity	Standard
Interface	Input: USB 3.0 Output: 4×USB 3.0
Material	ABS plastic
MOQ	MOQ: 500 pcs



HB2005 USB3.2 Gen1

5-Port Gigabit USB Hub

Capacity	Standard
Interface	Input: USB 3.0 + Type-C Output: 3×USB 3.0 + DC-C+RJ45
Material	Aluminum alloy
MOQ	MOQ: 500 pcs



HB2037 USB3.2 Gen1

USB 3.0 5-Port Hub

Capacity	Standard
Interface	Input: USB 3.0 Output: 3×USB 3.0 + Type-C 3.0 + DC-C
Material	ABS plastic
MOQ	MOQ: 500 pcs



HB2023 USB3.2 Gen1

Dual-Input 4-Port USB Hub

Capacity	Standard
Interface	Input: USB 3.0 + Type-C Output: 2×USB 2.0 + Type-C 2.0 + Type-C
Material	Aluminum alloy
MOQ	MOQ: 500 pcs



HB2090 USB3.2 Gen1

USB 3.0 5-Port Hub with DC Power

Capacity	Standard
Interface	Input: USB 3.0 Output: 4×USB 3.0 + DC-C
Material	ABS plastic
MOQ	MOQ: 500 pcs



HB2006 USB3.2 Gen1

USB-A/C to Gigabit Ethernet Adapter

Capacity	Standard
Interface	Input: USB 3.0 + Type-C Output: RJ45
Material	Aluminum alloy
MOQ	MOQ: 500 pcs

Custom logo printing (Laser / Silk-screen), bespoke packaging, and custom capacity configuration available. Contact sales for live tier pricing.

PRODUCT LINE CATALOG

High-Speed Card Readers

USB 3.0 & Type-C OTG Dual-Slot SD/TF Readers

Professional multi-slot high-speed card readers supporting SD, MicroSD (TF), and CF cards. Simultaneous dual-card read/write, OTG mobile phone direct offload, and durable zinc/aluminum alloy shells.



RD2003 SD3.0 SDR104

Single TF Card Reader

Capacity	Standard
Interface	Host: Type-C Card slots: TF
Material	ABS plastic
MOQ	MOQ: 500 pcs



RD2005 SD3.0 SDR104

Dual-Card Reader

Capacity	Standard
Interface	Host: USB 3.0 + Type-C Card slots: TF + SD
Material	Aluminum alloy
MOQ	MOQ: 500 pcs



RD3001 SD3.0 DDR225

DDR225 High-Speed Card Reader

Capacity	Standard
Interface	Host: Type-C Card slots: TF
Material	ABS plastic
MOQ	MOQ: 500 pcs



RD3015 SD3.0 DDR225

Dual-Head TF Card Reader

Capacity	Standard
Interface	Host: USB 3.0 + Type-C Card slots: TF
Material	Zinc alloy
MOQ	MOQ: 500 pcs



RD3012 SD3.0 DDR225

Magnetic Dual-Card Reader with PD

Capacity	Standard
Interface	Host: Type-C Card slots: TF + SD+PD100W
Material	Aluminum alloy
MOQ	MOQ: 500 pcs



RD2017 SD3.0 SDR104

CF Multi-Card Reader

Capacity	Standard
Interface	Host: USB 3.0 + Type-C Card slots: TF + SD + CF
Material	ABS plastic
MOQ	MOQ: 500 pcs

Custom logo printing (Laser / Silk-screen), bespoke packaging, and custom capacity configuration available. Contact sales for live tier pricing.

TAILORED MANUFACTURING

From Concept Artwork to Mass Production

LingC provides comprehensive end-to-end OEM and ODM services for worldwide distributors, retailers, tech brands, and corporate clients. We support flexible MOQ requirements starting from 100 units with fast sample prototyping.

✨ Branding & Logo Finishing

- **Laser Engraving**: Permanent, scratch-proof metallic finish for alloy casings.
- **Silk-Screen & Pad Printing**: Accurate Pantone matching for corporate branding.
- **Full-Color UV Printing**: High-resolution photographic prints for promotional gifts.

📦 Custom Packaging Solutions

- **Eco-Friendly Retail Blister Cards**: Ready for supermarket display racks.
- **Premium Tin Boxes & Gift Sets**: Laser cut EVA foam inserts for VIP corporate gifts.
- **Bulk Industrial Packaging**: Anti-static trays for assembly lines and distributors.

⚙️ Firmware & Software Preload

- **Data Preloading**: Non-erasable product videos, catalogs, or custom software.
- **Custom Disk Partitioning**: Read-only virtual CD-ROM + writable mass storage.
- **Custom Volume Label & Icon**: Show your brand name when inserted into PC/Mac.

RIGOROUS 5-STAGE TESTING

Standard Manufacturing & Quality Assurance Workflow

01 Wafer Screening
100% Original Grade-A Flash Chips with full capacity testing.

→

02 SMT Placement
High-speed automated SMT with AOI optical solder inspection.

→

03 Burn-In Cycling
High-low temperature thermal shock and continuous H2 read/write.

→

04 Assembly & Laser
Ultrasonic sealing, CNC alloy framing, and precision logo branding.

→

05 Final QA & Pack
Drop test, plug-cycle test, clean anti-static packaging before shipping.

Partner with a Verified Source Factory

Direct factory pricing, verified ISO certification, and dedicated English/Chinese technical sales support.

Cherie Xiao (肖倩)

International Business & Sales Representative

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WhatsApp / Mobile: +86 183 9095 2057

Official Website: https://www.lingctech.com

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Scan to connect on WeChat / 即刻微信联络

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Specifications are subject to individual production batch sheets. Certified models comply with ISO 9001/14001/45001, CE, FCC & RoHS.